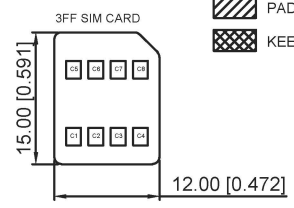
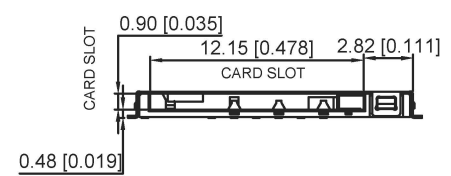


PAD AREA
 KEEP OUT AREA
 RECOMMENDED P.C.B LAYOUT
 COMPONENT SIDE (TOLERANCE ±0.05)

TECHNICAL CHARACTERISTICS

- General Characteristics
 - Dimensions: 15.75LX17.17WX1.50H mm
 - Weight: Approx 0.4±0.1g
 - Durability: 1500 cycles min.
- Electrical Characteristics
 - Contact resistance;
 - Date Contact: 150mΩ max
 - CD Switch: 500mΩ max
 - Insulation resistance: >1000MΩ/500V DC
- Solderability
 - Vapor phase: 215°C, 30sec. Max
 - IR reflow: 250°C, 5sec. Max
 - Manual soldering: 370°C, 3sec. Max
- Environmental Characteristics
 - Operating temperature: -40°C~+85°C
 - Operating humidity: 10%~95%RH



3FF SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved

ELECTRIC FUNCTION	DETECT SWITCH
WITHOUT CARD	CLOSED
CARD INSERTED	OPEN



ITEM	PART NAME	QTY	MATERIAL	FINISHING
1	HOUSING	1	HI-TEMP.PLASIC	Black UL94V-0
2	TERMINAL	9	COPPER ALLOY	Contact area: Gold plated
3	CD SWITCH	1	COPPER ALLOY	Contact area: Gold plated
4	SHELL	1	SUS	SMT area: Gold plated
5	SPRING	1	SWP	
6	HEART CAM	1	HI-TEMP.PLASIC	Black UL94V-0
7	CAM PIN	1	SUS	

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生效	日期
Δx	
Δx	
Δx	
MARK	DESCRIPTION
文件	工程
章	
REVISIONS	
www.helloxkb.com	www.helloxkb.com

DSND	DATE	SCALE: N/A	MODEL TYPE:
DWN	DATE	VIEW:	SIM CARD CONN
CHKD	DATE	UNIT: mm/in	PART NO.:
APPD	DATE	SIZE: A4	DWG NO.:
XKB INDUSTRIAL PRECISION CO., LIMITED			XKSIM-1511B-P9
WEIGHT	SHEET	REVISION	
1.0g	1/1	A0	

单击下面可查看定价，库存，交付和生命周期等信息

[>>XKB Connectivity\(中国星坤\)](#)